Analysis of AC electrical response for radio-frequency sputtered (Ba$_{0.5}$Sr$_{0.5}$)TiO$_3$ thin film

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Abstract

Through the measurement of dielectric dispersion as a function of frequency (100 Hz \(\leq f \leq 1\) MHz), we investigated the trapping dielectric relaxation of r.f.-sputtered (Ba$_{0.5}$Sr$_{0.5}$)TiO$_3$ film and proposed an equivalent circuit on the basis of the admittance and capacitance spectra. Admittance spectral studies in the temperature range of 200-420 K revealed the existence of a trap level. The trap, located at 0.05 eV, is envisaged to be responsible for the origin of dielectric relaxation and carrier concentration. The equivalent circuit, consisting of a series trapping resistance and capacitance combination in parallel with leakage resistance and high frequency limit capacitance, is adopted to explain satisfactorily the AC response and to identify the contribution of the shallow trap on the electrical properties of BST thin film. © 1999 Elsevier Science S.A. All rights reserved.

Keywords: Barium strontium titanate oxide (BST); Dielectric response; Impedance; Cole plot

1. Introduction

At present, ferroelectric films are well recognized to be excellent capacitor materials for dynamic random access memory (DRAM) in ultra large scale integration [1]. The most attractive advantage in ferroelectric materials over the conventional nitride-oxide is that the former have a very high dielectric constant, especially for memory densities higher than 64 Mb and above. Among those ferroelectric films, barium strontium titanate oxide (abbreviated BST) is a promising material candidate for DRAM because of its paraelectric phase, high dielectric constant and low temperature coefficient of capacitance. Although many articles on the electrical properties of BST films have been published, they primarily focused on a single-frequency test, which is typically selected at 1 k [2-7], 100 k [8,9] or 1 M Hz [10]. This kind of evaluation is appropriate for a defect-free single crystal material. It is commonly concluded [11-15] that the Pt/BST junction has Schottky-barrier rectifying properties. The electrons trapped at the interface sustains the Schottky-barrier and are compensated by positive-ionized shallow donors within the depletion region. Hence, the heterogeneity, resulting from the defect or impurity in the contact or grain, often leads to a dielectric relaxation as a function of frequency in Pt/BST/Pt capacitors. The dielectric relaxation greatly affects the electrical properties of the BST capacitor, such as field-stress leakage current [15], stored-charge loss [16] and pause refresh properties [17]. The dielectric relaxation can be analyzed over a wide range of measurement frequency and temperature. Takamura [18] and Watanabe et al. [19] have, respectively, investigated frequency-dependent dielectric response for RuO$_2$/BST and RuO$_2$/PZT capacitors, but the origin and role of dielectric relaxation in BST capacitors still remain unclear.

In this study, we employed the admittance spectroscopy and complex planes technique to identify the AC electrical response of polycrystalline Pt/BST thin film capacitors. The admittance spectroscopy is verified to be a useful method for detecting fast or shallow trap levels [20]. The complex plane analysis is another powerful tool used for characterizing the dielectric response of heterogeneous polycrystalline materials, such as BaTiO$_3$ ceramics [21,22], ZnO varistors [23], transparent conductors [24], and ferroelectric ceramics [25,26]. An equivalent circuit is required in this complex plane technique to provide realistic representation of experimental AC data of the polycrystalline film. Complex admittance ($Y^\ast$), impedance ($Z^\ast$) and capacitance ($C^\ast$) plots are three useful electrical parameters for characterizing the AC response of the film. When the AC data are systematically transformed into two or more complex planes [22,27,28],

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the appropriate equivalent circuit can be usually possible to identify. The purpose of this paper was to probe shallow defects using admittance spectroscopy and to propose a realistic equivalent circuit by three complex planes (impedance, admittance and capacitance) analyses so that the effect of dielectric relaxation on the electrical properties of BST film can be better understood.

2. Experimental procedure

The n-type (100) silicon wafer was cleaned by standard process. The SiO$_2$ layer was thermally grown in a furnace for obtaining a film thickness of 300 nm. The 100 nm thick Pt bottom electrode was deposited on the SiO$_2$ layer by an electron-gun. BST thin films on the bottom electrodes were deposited by r.f.-sputtering at a substrate temperature of 500°C. The sputtering gas consists of 50% Ar and 50% O$_2$ mixture with a total pressure of 10 mTorr. The film thickness was estimated to be 90 nm by using a Tencor Alpha-Step 200 profilometer. The Pt top electrodes with a thickness of 50 nm and diameters of 350 µm were patterned by the shadow mask process. The result of inductive coupled plasma analysis indicated that the BST thin films were composed of 50% Ba and 50% Sr. X-ray diffraction analysis indicates that the film belongs to the pervoskite cubic phase. The sample was mounted in a continuous flow liquid nitrogen cryostat capable of controlling the temperature of ±1 K between 150 and 420 K. The AC electrical response of the BST films was monitored with a computer controlled impedance analyzer (HP4194A). The AC electrical data, in the form of parallel capacitance ($C_p$) and conductance ($G_p$), were recorded in the frequency range of 100 Hz to 1 MHz at an AC signal amplitude of 0.1 V.

3. Results and discussion

The admittance ($Y^*$) and impedance ($Z^*$) can be defined in an expression relating the electrical current and applied voltage

$$I(\omega) = Y^*(\omega)V(\omega) = Z^*(\omega)^{-1}V(\omega)$$  (1)

For the purpose of this work, a complex capacitance plane is expressed as the following equation

$$C^*(\omega) = Y^*(\omega)/j\omega = Re(C^*) - jIm(C^*) = C_0(\varepsilon'_r-j\varepsilon''_r)$$

$$= C_p - jG_p/\omega$$  (2)

where $\omega$ is the angular frequency, $C_0$ the geometric capacitance in free space, $C_p$ and $G_p$, the equivalent parallel capacitance and conductance of entire circuit, respectively. Fig. 1 depicts the variation of relative real dielectric constant ($\varepsilon'_r$), imaginary dielectric constant ($\varepsilon''_r$) and loss tangent (tanδ) at $T = 300$ K.

Fig. 1. Frequency dependence of relative real dielectric constant ($\varepsilon'_r$), imaginary dielectric constant ($\varepsilon''_r$) and loss tangent (tanδ) at $T = 300$ K.
Fig. 3. (a) Complex impedance plot (Z*) of BST film at T = 300 K. (b) Complex capacitance plot (C*) of BST film at T = 300 K. (c) Complex admittance plot (Y*) of BST film at T = 300 K. The inset plot is the corresponding expanded section near the origin, from which we can determine the R_{DC} (\Gamma_{DC}).
The impedance $Z^*$ corresponds to a parallel $R-C$ circuit. On the other hand, a semicircular fit of the AC data in the complex $C^*$ planes (Cole–Cole plot) suggests a series equivalent $R-C$ circuit that represents the observed spectra. The impedance ($Z^*$) data in Fig. 3a lie on a single arc, and do not form a distinct semicircle. Hence, the parallel $R-C$ combination appears to be an unsatisfactory representation of AC response for our frequency range. On the contrary, the emergence of a semicircular plot in a complex capacitance plane (Fig. 3b) indicates that a series $R-C$ combination with a relaxation time ($\tau = 0.11$ ms) can equally represent an AC response of the BST film. In the complex $Y^*$ plane (Fig. 3c), the curve approaches the semicircle as the measured frequency tends to zero. A switching between the $C^*$ and $Y^*$ planes is in agreement with the observation reported by Grant [27]. On the basis of $C^*$ and $Y^*$ planes analyses [27], we proposed a practical equivalent circuit for BST capacitors, as shown in Fig. 4. The $C_\infty$ represents the high frequency capacitance due to the depletion region and $R_{\text{dc}}$ shows the low-field leakage resistance. The equivalent circuit in Fig. 4 also includes the contribution of a shallow trap ($E_i = 0.05$ eV) whose characteristic time constant, $\tau_i(T) = R_i(T) \times C_i(T)$, gives rise to a conductance peak when $\omega = 1/\tau_i$. The $C_i$ value can be determined by subtracting left and right intercepts on a semicircular relaxation in real $C^*$ axis. $R_i$ can be derived from the measured $\omega_p$ ($R_i = 1/C_i\omega_p$) and $R_{\text{dc}}$ is equal to a reciprocal of the left intercept on the real $Y^*$ axis [27]. The $C_\infty$ calculation can be described as the following: Supposing that the observed frequency dependence of capacitance was attributed to the dielectric after-effect, $C(f)$ could be written as $C(f) = C_\infty + C_0 \times f^{-\alpha-1}$ [15,32], where $C_\infty$ denotes the capacitance at high-frequency and $C_0$ the capacitance due to dielectric relaxation. By fitting this equation into our measured data, we found that $C(f)$ is $1.2 + 90 \times f^{-0.18}$ (nF) at $T = 200$ K and $0.37 + 10.6 \times f^{-0.21}$ (nF) at $T = 300$ K (see Fig. 5a,b). Fig. 6 displays the Cole–Cole plots of complex capacitance.
Table 1
Measured and calculated parametric values of the equivalent circuit shown in Fig. 4 extracted from analyses of the (C*) and (I*) planes at various temperatures.

<table>
<thead>
<tr>
<th>Temperature (K)</th>
<th>C* (nF)</th>
<th>R* (Ω)</th>
<th>ωp (rad/s)</th>
<th>C0 (nF)</th>
<th>RDC (Ω)</th>
<th>8°</th>
</tr>
</thead>
<tbody>
<tr>
<td>200</td>
<td>2.7</td>
<td>231 k</td>
<td>1.6 k</td>
<td>1.2</td>
<td>25 M</td>
<td>2</td>
</tr>
<tr>
<td>230</td>
<td>2.7</td>
<td>132 k</td>
<td>2.8 k</td>
<td>1.1</td>
<td>25 M</td>
<td>6</td>
</tr>
<tr>
<td>260</td>
<td>2.6</td>
<td>68.7 k</td>
<td>5.6 k</td>
<td>0.88</td>
<td>25 M</td>
<td>9</td>
</tr>
<tr>
<td>300</td>
<td>2.5</td>
<td>44.5 k</td>
<td>9.0 k</td>
<td>0.37</td>
<td>25 M</td>
<td>10</td>
</tr>
<tr>
<td>340</td>
<td>2.3</td>
<td>28.9 k</td>
<td>15 k</td>
<td>0.06</td>
<td>25 M</td>
<td>11</td>
</tr>
<tr>
<td>420</td>
<td>2.2</td>
<td>15.1 k</td>
<td>30 k</td>
<td>–</td>
<td>25 M</td>
<td>11</td>
</tr>
</tbody>
</table>

planes at various temperatures. On the basis of the above described concept and procedure, we extracted the related parameters of the equivalent circuit as indicated in Fig. 4 at various temperatures and list them in Table 1. C* at T = 420 K is difficult to calculate because of strong capacitance dispersion. R* shows an Arrhenius-type temperature dependence and its activation energy was calculated to be 0.08 eV, as shown in Fig. 7. RDC remains constant until 420 K and both C* and C0 decrease as temperature is increased (see Fig. 8). The peak frequency is rather inversely proportional to R* than C*. The depression angle 8 of a semicircular response in a C* plane is defined when the center of a semicircle lies below the x-axis instead of on the x-axis, as illustrated in Fig. 3b. Here we obtain the 8 values on the basis of the measured data indicated in Fig. 6 and the non-Debye empirical relation reported in Ref. [33]. The non-zero value of 8 has been reported to correspond to the distribution of relaxation time [33] and reflects the degree of uniformity in the conductance relaxation. Joncher [34] showed that 8 is related to the extent of the screening effect caused by the hopping charges when it cannot follow the changes of the polarization brought about by an alternating electric field. The value of 8 increases as the temperature increases (see Fig. 8) because of a large number of free carriers whose motion is dominated by discontinuous hops and cannot be followed by an immediate readjustment [23]. Taking account of a dynamic random access memory application, the dielectric relaxation would result in less than 10% loss of storage charge during the refresh cycle and hence the film's DC leakage less affects the device operation [16].

4. Conclusions

In this paper, we studied the dielectric relaxation of BST films in the frequency range of 100 Hz to 1 MHz. The dielectric relaxation arises from a shallow trap (Ei = 0.05 eV), which is detected by the admittance spectra carried out at various temperature (200 ≤ T ≤ 420 K). This trap also plays an important role in the contribution of the dielectric loss and carrier concentration. In order to qualify the trapping effect on the capacitance and admittance, we proposed an equivalent circuit that consisting of a series trapping resistance and capacitance combination in parallel with DC resistance and high frequency limit capacitance. This equivalent circuit model can provide a viable mean by which processing variables can be expected to be related to BST electrical properties.

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References


